

**SEMITOP<sup>®</sup> 3**

## IGBT Module

**SK50GB067**

**SK50GAL067**

**SK50GAR067**

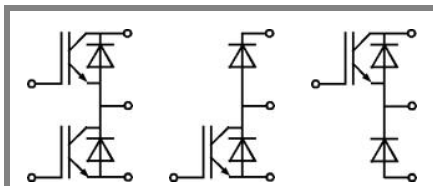
Target Data

### Features

- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DCB)
- Hyperfast NPT technology IGBT
- N-channel homogeneous silicon structure (NPT Non-Punch-Through IGBT)
- Positive  $V_{ce,sat}$  temperature coefficient (Easy paralleling)
- Low tail current with low temperature dependence
- Low threshold voltage

### Typical Applications

- Switching (not for linear use)
- High Frequencies Applications
- Welding generator
- Switched mode power supplies
- UPS



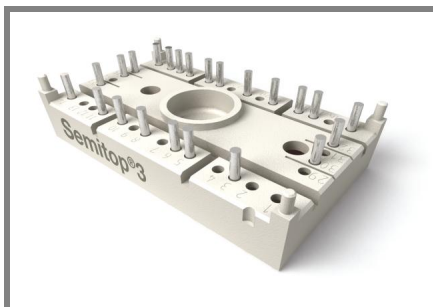
GB

GAL

GAR

Absolute Maximum Ratings		$T_s = 25\text{ °C}$ , unless otherwise specified		
Symbol	Conditions	Values		Units
<b>IGBT</b>				
$V_{CES}$	$T_j = 25\text{ °C}$	600		V
$I_C$	$T_j = 125\text{ °C}$	$T_s = 25\text{ °C}$	83	A
		$T_s = 80\text{ °C}$	54	A
$I_{CRM}$	$I_{CRM} = 2 \times I_{Cnom}$	240		A
$V_{GES}$		± 20		V
$t_{psc}$	$V_{CC} = 300\text{ V}; V_{GE} \leq 20\text{ V}; T_j = 125\text{ °C}$ $V_{CES} < 600\text{ V}$	10		µs
<b>Inverse Diode</b>				
$I_F$	$T_j = 150\text{ °C}$	$T_s = 25\text{ °C}$	90	A
		$T_s = 80\text{ °C}$	56	A
$I_{FRM}$	$I_{FRM} = 2 \times I_{Fnom}$			A
$I_{FSM}$	$t_p = 10\text{ ms}$ ; sinusoidal	$T_j = \text{°C}$	360	A
<b>Freewheeling Diode</b>				
$I_F$	$T_j = 150\text{ °C}$	$T_s = 25\text{ °C}$	90	A
		$T_s = 80\text{ °C}$	56	A
$I_{FRM}$				A
$I_{FSM}$	$t_p = \text{ms}$ ;	$T_j = \text{°C}$	360	A
<b>Module</b>				
$I_{t(RMS)}$				A
$T_{vj}$		-40 ... +150		°C
$T_{stg}$		-40 ... +125		°C
$V_{isol}$	AC, 1 min.	2500		V

Characteristics		$T_s = 25\text{ °C}$ , unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
<b>IGBT</b>					
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 1,2\text{ mA}$	3	4	5	V
$I_{CES}$	$V_{GE} = 0\text{ V}, V_{CE} = V_{CES}$			0,008	mA
$I_{GES}$	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}$			480	nA
$V_{CE0}$				2	V
$r_{CE}$	$V_{GE} = 15\text{ V}$			12,5	mΩ
$V_{CE(sat)}$	$I_{Cnom} = 120\text{ A}, V_{GE} = 15\text{ V}$	$T_j = 25\text{ °C}_{chiplev.}$	2,8	3,15	V
		$T_j = 125\text{ °C}_{chiplev.}$	3,5	4	V
$C_{ies}$	$V_{CE} = 25, V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$	6		nF
$C_{oes}$			0,6		nF
$C_{res}$			0,36		nF
$t_{d(on)}$	$R_{Gon} = 11\text{ Ω}$	$V_{CC} = 400\text{ V}$ $I_{Cnom} = 120\text{ A}$	22		ns
$t_r$			10		ns
$E_{on}$	$R_{Goff} = 11\text{ Ω}$	$T_j = 125\text{ °C}$ $V_{GE} = \pm 15\text{ V}$	7,5		mJ
$t_{d(off)}$			280		ns
$t_f$			26		ns
$E_{off}$			4		mJ
$R_{th(j-s)}$	per IGBT			0,45	K/W



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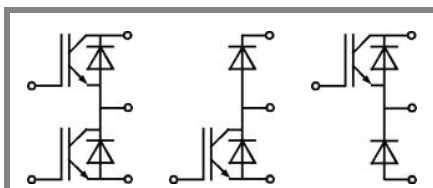
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### Characteristics

Symbol	Conditions	min.	typ.	max.	Units
<b>Inverse Diode</b>					
$V_F = V_{EC}$	$I_{Fnom} = 120 \text{ A}; V_{GE} = 0 \text{ V}$			2	V
					$T_j = 25 \text{ }^\circ\text{C}_{chiplev.}$
			1,25		$T_j = 150 \text{ }^\circ\text{C}_{chiplev.}$
$V_{F0}$					$T_j = 25 \text{ }^\circ\text{C}$
			1		$T_j = 150 \text{ }^\circ\text{C}$
$r_F$					$T_j = 25 \text{ }^\circ\text{C}$
			4		$T_j = 150 \text{ }^\circ\text{C}$
$I_{RRM}$	$I_{Fnom} = 120 \text{ A}$				$T_j = 125 \text{ }^\circ\text{C}$
$Q_{rr}$	$di/dt = -100 \text{ A}/\mu\text{s}$				A
$E_{rr}$	$V_{CC} = 400 \text{ V}$				$\mu\text{C}$
					mJ
$R_{th(j-s)D}$	per diode			0,8	K/W
$M_s$	to heat sink	2,25		2,5	Nm
w			29		g

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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